



INA157

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High-Speed, Precision DIFFERENCE AMPLIFIER

FEATURES

DESIGNED FOR LOW COST

● LOW OFFSET VOLTAGE: ±500μV max

■ LOW OFFSET DRIFT: ±2µV/°C

● LOW GAIN ERROR: ±0.05% max

• WIDE BANDWIDTH: 3MHz

HIGH SLEW RATE: 14V/μs

● FAST SETTLING TIME: 3µs to 0.01%

WIDE SUPPLY RANGE: ±4V to ±18V
 LOW QUIESCENT CURRENT: 2.4mA

SO-8 SURFACE-MOUNT PACKAGE

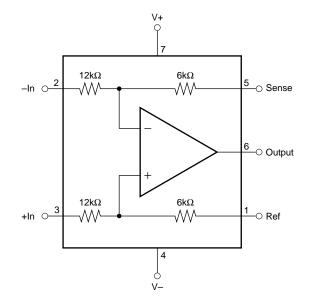
APPLICATIONS

- DIFFERENTIAL INPUT AMPLIFIER
- INSTRUMENTATION AMPLIFIER BUILDING BLOCK
- G = 1/2 AMPLIFIER
- G = 2 AMPLIFIER
- DIFFERENTIAL CURRENT RECEIVER
- VOLTAGE-CONTROLLED CURRENT SOURCE
- GROUND LOOP ELIMINATOR
- **CURRENT SHUNT MONITOR**

DESCRIPTION

The INA157 is a high slew rate, G=1/2 or G=2 difference amplifier consisting of a precision op amp with a precision resistor network. The on-chip resistors are laser trimmed for accurate gain and high common-mode rejection. Excellent TCR tracking of the resistors maintains gain accuracy and common-mode rejection over temperature. The input common-mode voltage range extends beyond the positive and negative supply rails. It operates on $\pm 4V$ to $\pm 18V$ supplies.

The difference amplifier is the foundation of many commonly used circuits. The INA157 provides this circuit function without using an expensive precision resistor network. The INA157 is available in a SO-8 surface-mount package and is specified for operation over the extended industrial temperature range, -40° C to $+85^{\circ}$ C.



International Airport Industrial Park • Mailing Address: PO Box 11400, Tucson, AZ 85734 • Street Address: 6730 S. Tucson Blvd., Tucson, AZ 85766 • Tel: (520) 746-1111

Twx: 910-952-1111 • Internet: http://www.burr-brown.com/ • Cable: BBRCORP • Telex: 066-6491 • FAX: (520) 889-1510 • Immediate Product Info: (800) 548-6132

SPECIFICATIONS: $V_S = \pm 15V$ At $T_A = +25$ °C, $V_S = \pm 15V$, $R_L = 2k\Omega$ connected to ground, and reference pin connected to ground, unless otherwise noted.

| | | | INA157U | | ! | | | |
|-------------------------------------|--|-----------|----------|--------|-----|-----|--------|--------------------|
| PARAMETER | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| OFFSET VOLTAGE(1) | FSET VOLTAGE ⁽¹⁾ RTO | | | | | | | |
| Initial ⁽¹⁾ | | | ±100 | ±500 | | * | ±1000 | μV |
| vs Temperature | | | ±2 | ±20 | | * | * | μV/°C |
| vs Power Supply | $V_{S} = \pm 4V \text{ to } \pm 18V$ | | ±5 | ±60 | | * | * | μV/V |
| vs Time | | | 0.25 | | | * | | μV/mo |
| INPUT IMPEDANCE(2) | | | | | | | | |
| Differential | | | 24 | | | * | | kΩ |
| Common-Mode | | | 18 | | | * | | kΩ |
| INPUT VOLTAGE RANGE | | | | | | | | |
| Common-Mode Voltage Range | | | | | | | | |
| Positive | $V_O = 0V$ | 3(V+)-7.5 | 3(V+)-6 | | * | * | | V |
| Negative | $V_O = 0V$ | 3(V-)+7.5 | 3(V-)+3 | | * | * | | V |
| S . | $V_{CM} = -37.5 \text{V to } 37.5 \text{V}, R_S = 0\Omega$ | 86 | 96 | | 80 | * | | dB |
| OUTPUT VOLTAGE NOISE(3) | RTO | | | | | • | | |
| f = 0.1Hz to 10Hz | KIO | | 1.3 | | | * | | μVp-p |
| f = 1kHz | | | 26 | | | * | | nV/√ Hz |
| GAIN | | | 20 | | | * | | 1107 1112 |
| Initial | | | 0.5 | | | *** | | V/V |
| Error | 101/40 : 101/ | | 0.5 | ±0.05 | | * | 10.4 | % % |
| | $V_0 = -10V \text{ to } +10V$ | | ±0.01 | | | | ±0.1 | |
| vs Temperature | 101/ | | ±1 | ±10 | | * | * | ppm/°C |
| Nonlinearity | $V_0 = -10V \text{ to } +10V$ | | ±0.0001 | ±0.001 | | * | ±0.002 | % of FS |
| OUTPUT | | | | | | | | |
| Voltage, Positive | | (V+)-2 | (V+)-1.8 | | * | * | | V |
| Negative | | (V-)+2 | (V-)+1.6 | | * | * | | V |
| Current Limit, Continuous to Common | | | ±60 | | | * | | mA _ |
| Capacitive Load (stable operation) | | | 500 | | | * | | pF |
| FREQUENCY RESPONSE | | | | | | | | |
| Small-Signal Bandwidth | −3dB | | 4 | | | * | | MHz |
| Slew Rate | | | 14 | | | * | | V/μs |
| Settling Time: 0.1% | 10V Step, C _L = 100pF | | 2 | | | * | | μs |
| 0.01% | 10V Step, C _L = 100pF | | 3 | | | * | | μs |
| Overload Recovery Time | 50% Overdrive | | 3 | | | * | | μs |
| POWER SUPPLY | | | | | | | | |
| Rated Voltage | | | ±15 | | | * | | V |
| Operating Voltage Range | | ±4 | | ±18 | * | | * | V |
| Quiescent Current | $I_O = 0mA$ | | ±2.4 | ±2.9 | | * | * | mA |
| TEMPERATURE RANGE | | | | | | | | |
| Specified | | -40 | | +85 | * | | * | °C |
| Operation | | -55 | | +125 | * | | * | °C |
| Storage | | -55 | | +125 | * | | * | °C |
| Thermal Resistance, Θ_{JA} | | | | | | | | |
| SO-8 Surface-Mount | | | 150 | | | * | | °C/W |

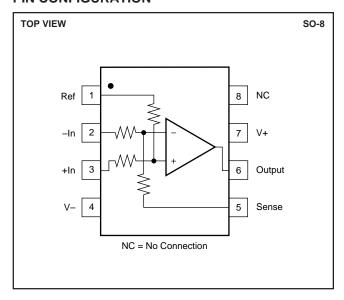
^{*}Specifications the same as INA157U.

NOTES: (1) Includes effects of amplifier's input bias and offset currents. (2) Internal resistors are ratio matched but have ±20% absolute value. (3) Includes effects of amplifier's input current noise and thermal noise contribution of resistor network.

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PIN CONFIGURATION



ABSOLUTE MAXIMUM RATINGS(1)

| Supply Voltage, V+ to V | 40V |
|-----------------------------------|----------------|
| Input Voltage Range | ±80V |
| Output Short Circuit (to ground) | Continuous |
| Operating Temperature | 55°C to +125°C |
| Storage Temperature | 55°C to +125°C |
| Junction Temperature | +150°C |
| Lead Temperature (soldering, 10s) | +300°C |

NOTE: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability.



This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION

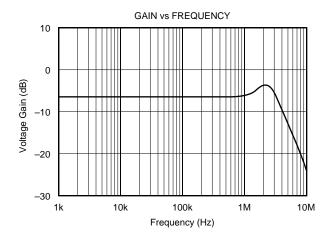
| PRODUCT | PACKAGE | PACKAGE DRAWING NUMBER ⁽¹⁾ | SPECIFIED TEMPERATURE RANGE | PACKAGE MARKING | ORDERING NUMBER ⁽²⁾ | TRANSPORT MEDIA |
|----------|--------------------|---|-----------------------------------|--------------------|-----------------------------------|------------------------|
| INA157U | SO-8 Surface-Mount | 182 | -40°C to +85°C | INA157U | INA157U INA157U/2K5 | Rails Tape and Reel |
| INA157UA | SO-8 Surface-Mount | 182 " | –40°C to +85°C | INA157UA " | INA157UA INA157UA/2K5 | Rails Tape and Reel |

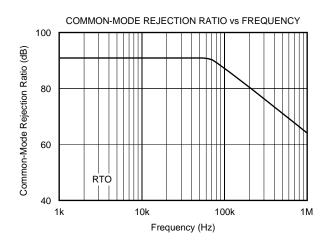
NOTES: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book. (2) Models with a slash (/) are available only in Tape and Reel in the quantities indicated (e.g., /2K5 indicates 2500 devices per reel). Ordering 2500 pieces of "INA157U/2K5" will get a single 2500-piece Tape and Reel. For detailed Tape and Reel mechanical information, refer to Appendix B of Burr-Brown IC Data Book.

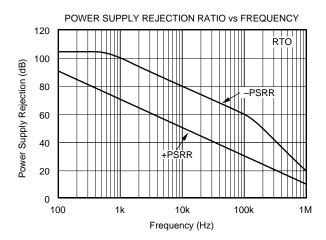
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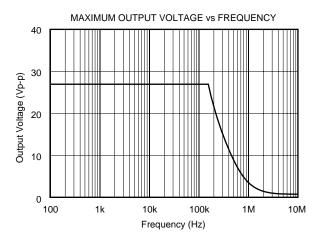
TYPICAL PERFORMANCE CURVES

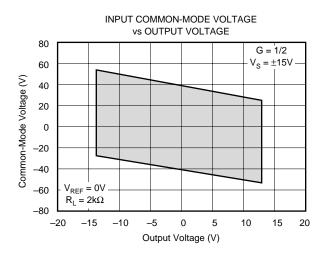
At $T_A = +25$ °C, $V_S = \pm 15$ V, and G = 1/2, unless otherwise noted.

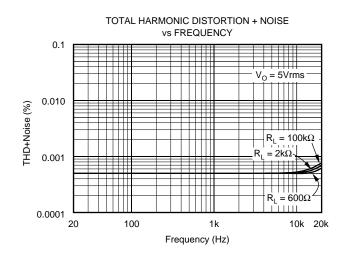






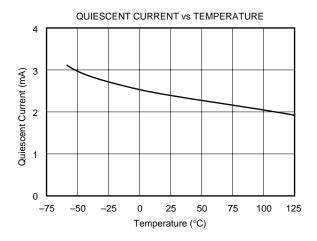


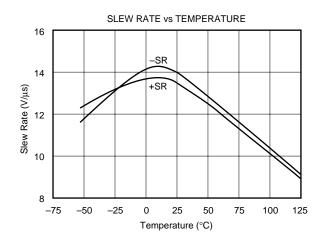


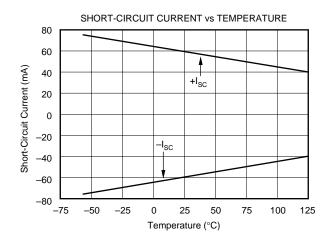


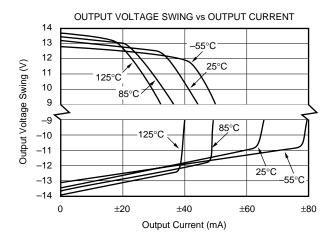
TYPICAL PERFORMANCE CURVES (CONT)

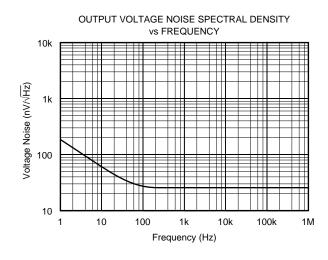
At $T_A = +25$ °C, $V_S = \pm 15$ V, and G = 1/2, unless otherwise noted.

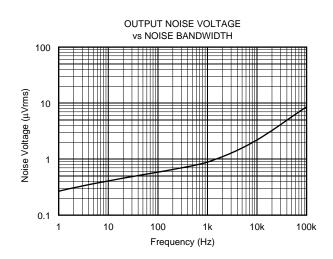






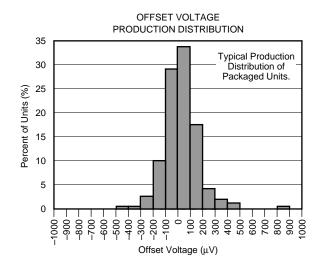


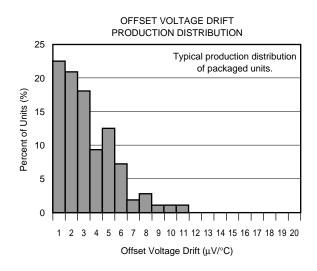


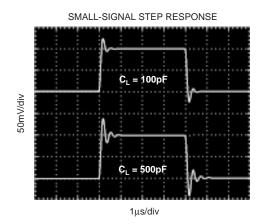


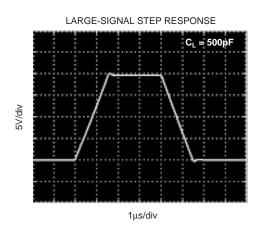
TYPICAL PERFORMANCE CURVES (CONT)

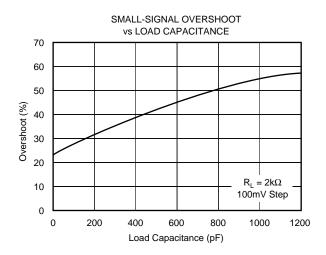
At $T_A = +25$ °C, $V_S = \pm 15$ V, and G = 1/2, unless otherwise noted.













APPLICATIONS INFORMATION

The INA157 is a difference amplifier suitable for a wide range of general-purpose applications. Figure 1 shows the basic G=1/2 configuration. The input and feedback resistors can be reversed to achieve G=2, as shown in Figure 2. For applications requiring G=1, the INA154 is recommended.

Decoupling capacitors are strongly recommended for applications with noisy or high impedance power supplies. The capacitors should be placed close to the device pins as shown in Figure 1.

As shown in Figure 1, the output is referred to the reference terminal (pin 1). A voltage applied to this pin will be summed with the output signal. The differential input signal is connected to pins 2 and 3. The source impedances connected to the inputs must be nearly equal to assure good common-mode rejection. A 5Ω mismatch in source impedance will degrade the common-mode rejection of a typical device to approximately 77dB (RTO). If the source has a known impedance mismatch, an additional resistor in series with the opposite input can be used to preserve good common-mode rejection.

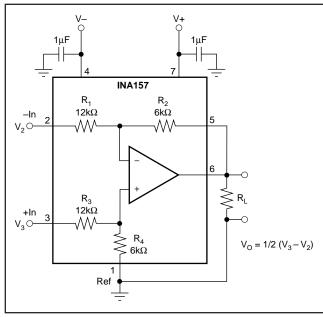


FIGURE 1. G = 1/2 Differential Amplifier (basic power supply and signal connections).

OPERATING VOLTAGE

The INA157 operates from ±4V to ±18V supplies with excellent performance. Most behavior remains unchanged throughout the full operating voltage range. Parameters which vary significantly with operating voltage are shown in the Typical Performance Curves.

INPUT VOLTAGE RANGE

The INA157 can accurately measure differential signals that are above the positive or negative power supply rail. In a gain of 1/2, the linear common-mode range extends from $3 \cdot (V+) - 7.5V$ to $3 \cdot (V-) + 7.5V$. See the Typical Performance Curve, "Input Common-Mode Range vs Output Voltage."

OFFSET VOLTAGE TRIM

The INA157 is laser trimmed for low offset voltage and drift. Most applications require no external offset adjustment. Figure 3 shows an optional circuit for trimming the output offset voltage. The output is referred to the output reference terminal (pin 1), which is normally grounded. A voltage applied to the Ref terminal will be summed with the output signal. This can be used to null offset voltage as shown in Figure 3. The source impedance of a signal applied to the Ref terminal should be less than 10Ω to maintain good common-mode rejection.

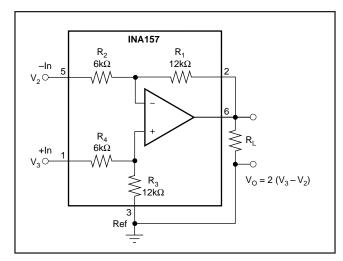


FIGURE 2. G = 2 Differential Amplifier.

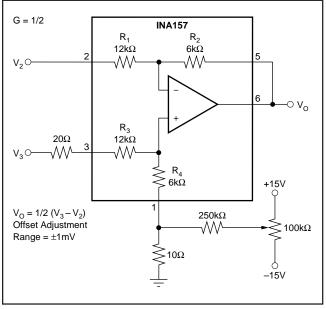


FIGURE 3. Offset Adjustment.



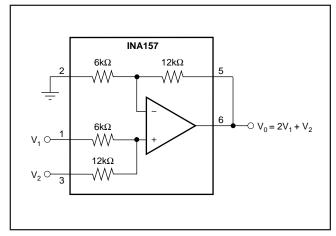
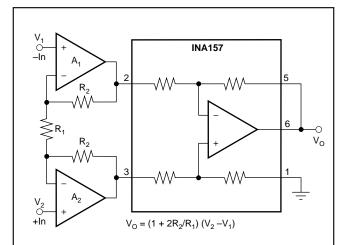


FIGURE 4. Precision Summing Amplifier.



The INA157 can be combined with op amps to form a complete instrumentation amplifier with specialized performance characteristics. Burr-Brown offers many complete high performance IAs. Products with related performances are shown at the right.

| A ₁ , A ₂ | FEATURE | SIMILIAR COMPLETE BURR-BROWN IAs |
|---------------------------------|-----------------------------|-------------------------------------|
| OPA227 | Low Noise | INA103 |
| OPA129 | Ultra Low Bias Current (fA) | INA116 |
| OPA277 | Low Offset Drift, Low Noise | INA114, INA128 |
| OPA2134 | FET Input (pA) | INA111, INA121 |

FIGURE 5. Precision Instrumentation Amplifier.

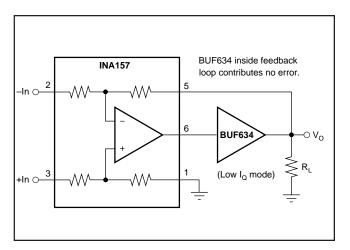


FIGURE 6. Boosting Output Current.

The difference amplifier is a highly versatile building block that is useful in a wide variety of applications. See the INA105 data sheet for additional applications ideas, including:

- Current Receiver with Compliance to Rails
- ±10V Precision Voltage Reference
- ±5V Precision Voltage Reference
- Precision Average Value Amplifier
- Precision Bipolar Offsetting
- Precision Summing Amplifier with Gain
- Instrumentation Amplifier Guard Drive Generator
- Precision Summing Instrumentation Amplifier
- Precision Absolute Value Buffer
- Precision Voltage-to-Current Converter with Differential Inputs
- Isolating Current Source
- Differential Output Difference Amplifier
- Isolating Current Source with Buffering Amplifier for Greater Accuracy
- Window Comparator with Window Span and Window Center Inputs
- Precision Voltage-Controlled Current Source with Buffered Differential Inputs and Gain
- Digitally Controlled Gain of ±1 Amplifier



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PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|--------------|-------------------------------|---------------------|--------------|-------------------------|---------|
| INA157U | ACTIVE | SOIC | D | 8 | 75 | RoHS & Green | Call TI | Level-3-260C-168 HR | -40 to 85 | INA 157U | Samples |
| INA157U/2K5 | ACTIVE | SOIC | D | 8 | 2500 | RoHS & Green | Call TI | Level-3-260C-168 HR | | INA 157U | Samples |
| INA157UA | ACTIVE | SOIC | D | 8 | 75 | RoHS & Green | Call TI | Level-3-260C-168 HR | | INA 157U A | Samples |
| INA157UA/2K5 | ACTIVE | SOIC | D | 8 | 2500 | RoHS & Green | Call TI | Level-3-260C-168 HR | | INA 157U A | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- ⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



PACKAGE OPTION ADDENDUM

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| INA157U/2K5 | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |
| INA157UA/2K5 | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |

PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| INA157U/2K5 | SOIC | D | 8 | 2500 | 356.0 | 356.0 | 35.0 |
| INA157UA/2K5 | SOIC | D | 8 | 2500 | 356.0 | 356.0 | 35.0 |

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|----------|--------------|--------------|------|-----|--------|--------|--------|--------|
| INA157U | D | SOIC | 8 | 75 | 506.6 | 8 | 3940 | 4.32 |
| INA157UA | D | SOIC | 8 | 75 | 506.6 | 8 | 3940 | 4.32 |

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